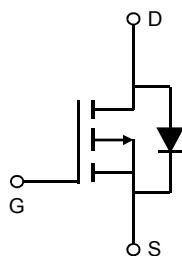
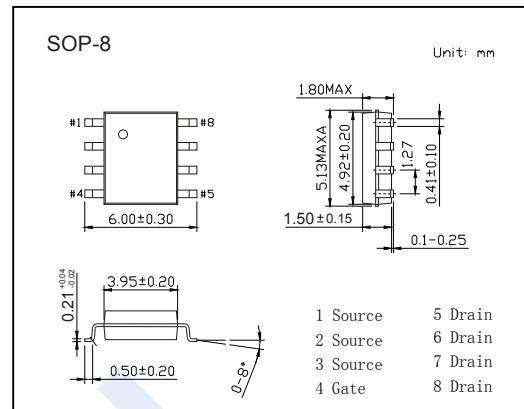


P-Channel MOSFET

AO4453 (KO4453)

■ Features

- V_{DS} (V) = -12V
- I_D = -9 A (V_{GS} = -4.5V)
- $R_{DS(ON)} < 19m\Omega$ (V_{GS} = -4.5V)
- $R_{DS(ON)} < 22m\Omega$ (V_{GS} = -3.3V)
- $R_{DS(ON)} < 26m\Omega$ (V_{GS} = -2.5V)
- $R_{DS(ON)} < 36m\Omega$ (V_{GS} = -1.8V)
- $R_{DS(ON)} < 50m\Omega$ (V_{GS} = -1.5V)



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	-12	V
Gate-Source Voltage	V_{GS}	± 8	
Continuous Drain Current	I_D	-9	A
		-7	
Pulsed Drain Current	I_{DM}	-55	
Avalanche Current	I_{AS}	20	
Avalanche Energy	E_{AS}	20	mJ
Power Dissipation	P_D	2.5	W
		1.6	
Thermal Resistance.Junction- to-Ambient	R_{thJA}	50	$^\circ C/W$
		85	
Thermal Resistance.Junction- to-Lead	R_{thJL}	30	$^\circ C$
Junction Temperature	T_J	150	
Junction Storage Temperature Range	T_{stg}	-55 to 150	

P-Channel MOSFET

AO4453 (KO4453)

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =-250 μ A, V _{GGS} =0V	-12			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DSS} =-12V, V _{GGS} =0V			-1	uA
		V _{DSS} =-12V, V _{GGS} =0V, T _J =55°C			-5	
Gate-Body leakage current	I _{GSS}	V _{DSS} =0V, V _{GGS} =±8V			±100	nA
Gate Threshold Voltage	V _{GGS(th)}	V _{DSS} =V _{GGS} , I _D =-250uA	-0.3		-0.9	V
Static Drain-Source On-Resistance	R _{DSS(on)}	V _{GGS} =-4.5V, I _D =-9A			19	m Ω
		V _{GGS} =-4.5V, I _D =-9A, T _J =125°C			25	
		V _{GGS} =-3.3V, I _D =-7A			22	
		V _{GGS} =-2.5V, I _D =-6A			26	
		V _{GGS} =-1.8V, I _D =-4A			36	
		V _{GGS} =-1.5V, I _D =-1A			50	
On state drain current	I _{D(on)}	V _{GGS} =-4.5V, V _{DSS} =-5V	-55			A
Forward Transconductance	g _{FS}	V _{DSS} =-5V, I _D =-9A		33		S
Input Capacitance	C _{iss}	V _{GGS} =0V, V _{DSS} =-6V, f=1MHz		1370		pF
Output Capacitance	C _{oss}			350		
Reverse Transfer Capacitance	C _{rss}			258		
Gate resistance	R _g	V _{GGS} =0V, V _{DSS} =0V, f=1MHz		10	20	Ω
Total Gate Charge	Q _g	V _{GGS} =-4.5V, V _{DSS} =-6V, I _D =-9A		12.7	18	nC
Gate Source Charge	Q _{gs}			1.7		
Gate Drain Charge	Q _{gd}			3.4		
Turn-On Delay Time	t _{d(on)}	V _{GGS} =-4.5V, V _{DSS} =-6V, R _L =0.67Ω, R _{GEN} =3Ω		11		ns
Turn-On Rise Time	t _r			25		
Turn-Off Delay Time	t _{d(off)}			70		
Turn-Off Fall Time	t _f			41.5		
Body Diode Reverse Recovery Time	t _{rr}	I _F =-9A, dI/dt=100A/us		20.7		nC
Body Diode Reverse Recovery Charge	Q _{rr}			5.2		
Maximum Body-Diode Continuous Current	I _s				-3.5	A
Diode Forward Voltage	V _{SD}	I _s =-1A, V _{GGS} =0V			-1	V

Note :The static characteristics in Figures 1 to 6 are obtained using <300us pulses, duty cycle 0.5% max.

■ Marking

Marking	4453 KC****
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P-Channel MOSFET

AO4453 (KO4453)

■ Typical Characteristics

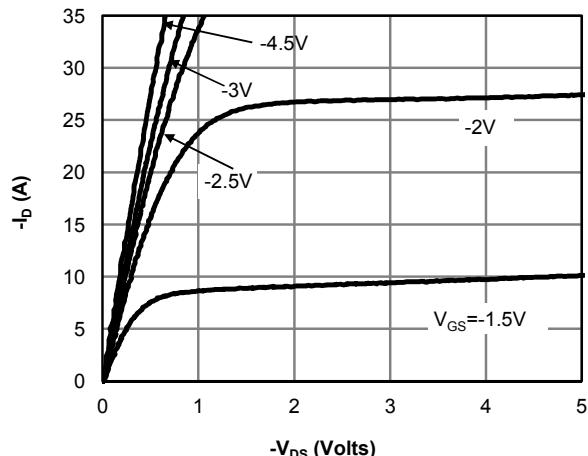


Fig 1: On-Region Characteristics (Note E)

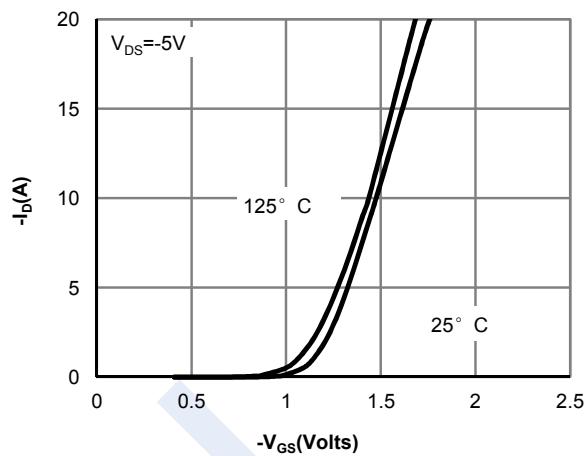


Figure 2: Transfer Characteristics (Note E)

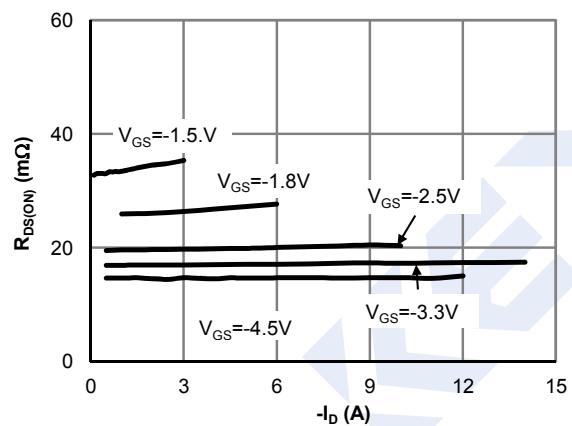


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

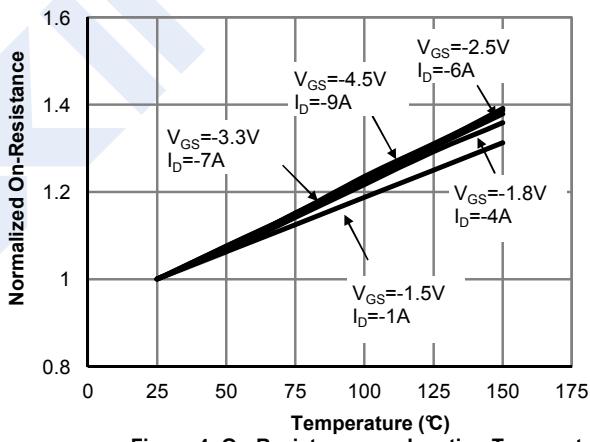


Figure 4: On-Resistance vs. Junction Temperature (Note E)

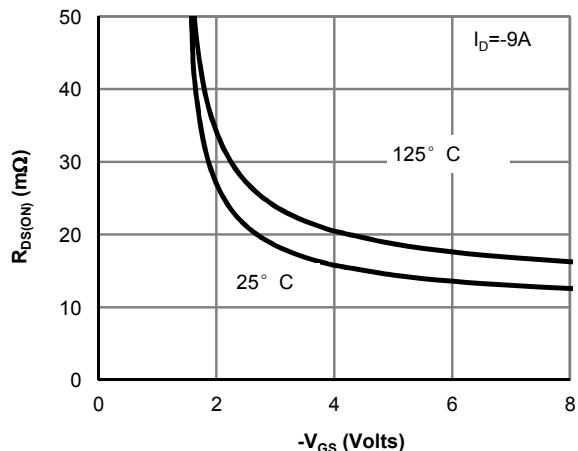


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

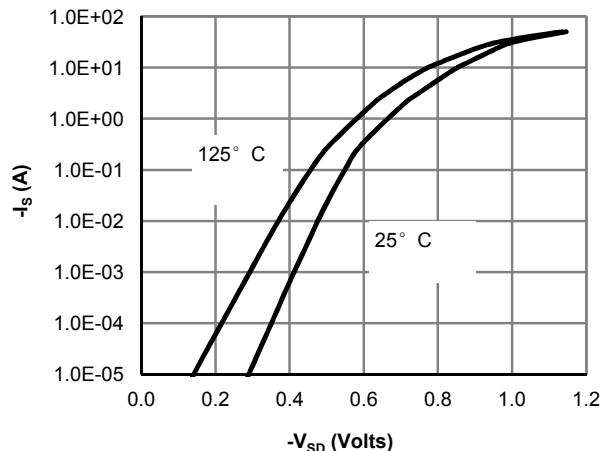


Figure 6: Body-Diode Characteristics (Note E)

P-Channel MOSFET

AO4453 (KO4453)

■ Typical Characteristics

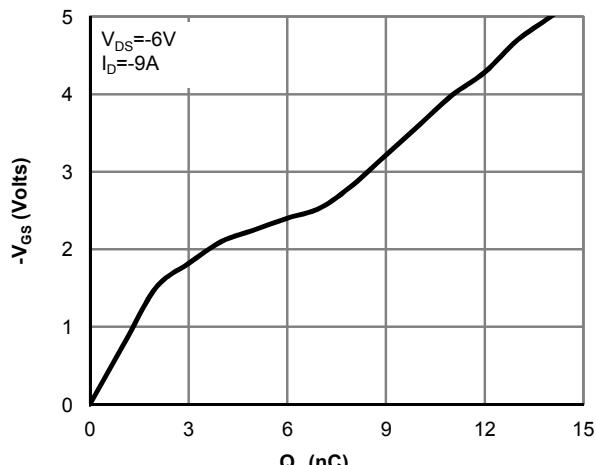


Figure 7: Gate-Charge Characteristics

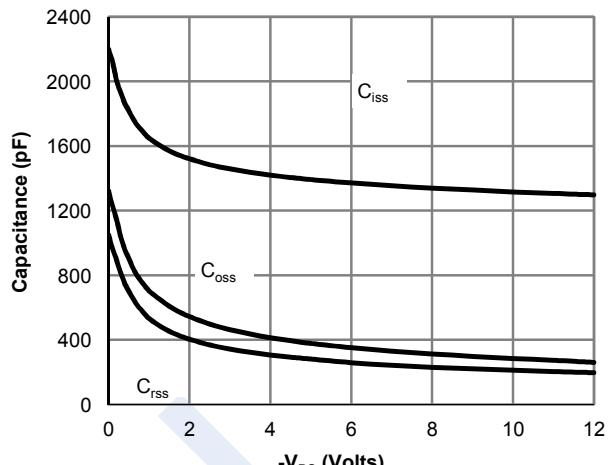


Figure 8: Capacitance Characteristics

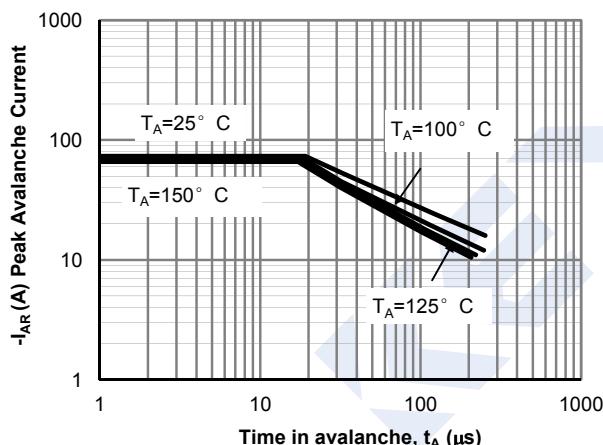


Figure 9: Single Pulse Avalanche capability (Note C)

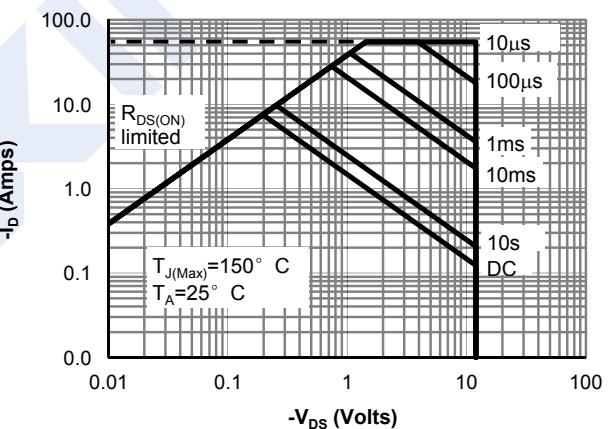


Figure 10: Maximum Forward Biased Safe Operating Area (Note F)

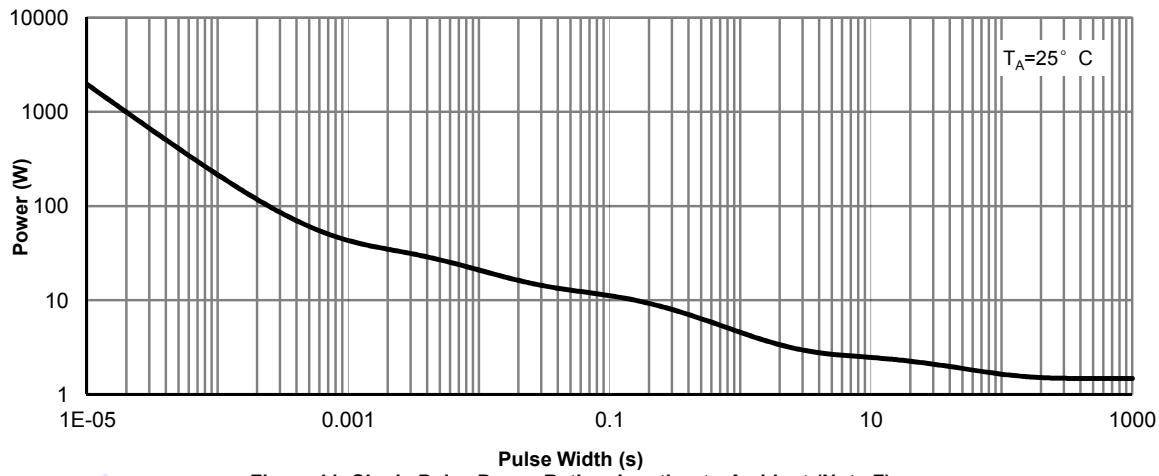


Figure 11: Single Pulse Power Rating Junction-to-Ambient (Note F)

P-Channel MOSFET**AO4453 (KO4453)**

■ Typical Characteristics

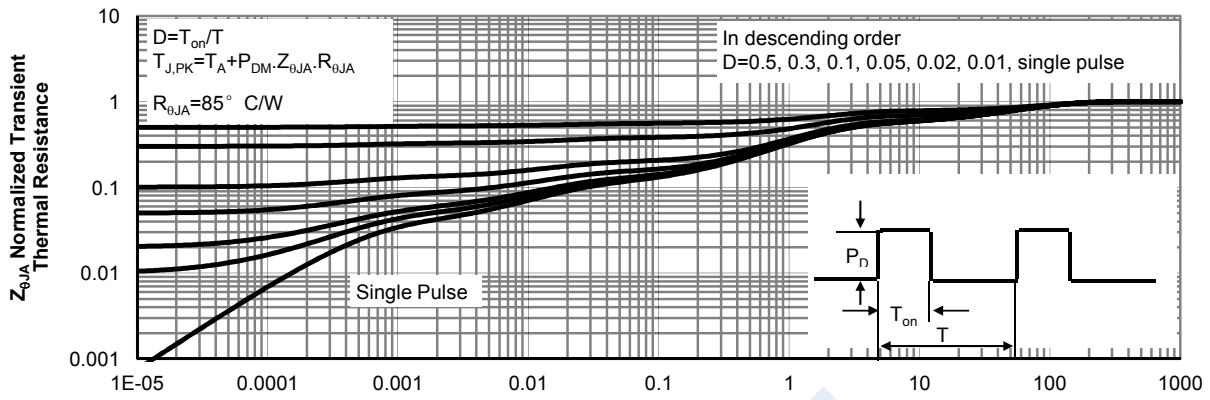


Figure 12: Normalized Maximum Transient Thermal Impedance (Note F)